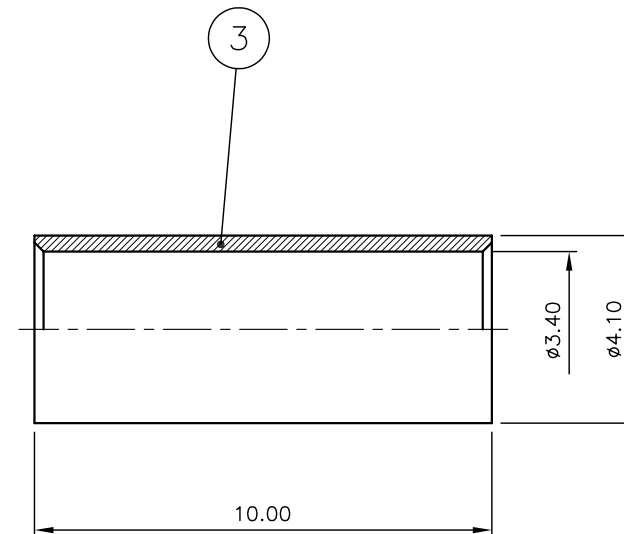
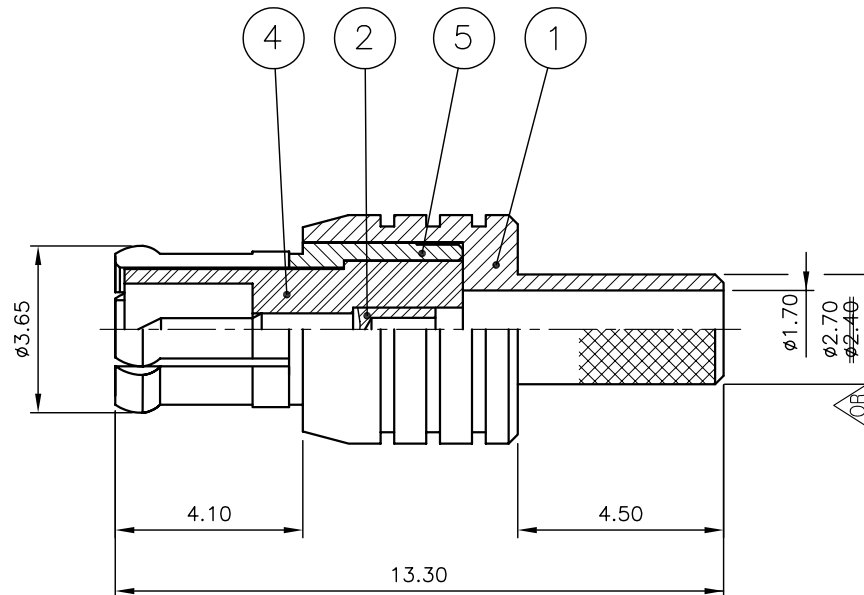


REVISION		
REV	DESCRIPTION	DATE
IR	최초 개정	2008.11.19.
A	설번처리 No. 200907-0005 [ASS'Y 시 PIN 편심 개선 치수 변경]	2009.07.14.
OR	설번처리 No. 201004-0005 [케이블 압착부 외경 변경]	2010.04.05.



Notes

1. RoHS & Pb-FREE
2. JACK SMOOTH SPECIAL TYPE

5	JACK	1	BeCu	Gold Plate	DJA00117-5/1
4	INSULATOR	1	TEFLON		DIN00066-N/2 DIN00066-N/1 (H1001)
3	FERRULE	1	MBsBD	Gold Plate	DFE00041-5/1 (F3009)
2	CONTACT	1	MBsBD	Gold Plate	DCT00063-5/2 DCT00063-5/1 (F1001)
1	BODY	1	MBsBD	Gold Plate	DBD00030-5/1 (D1002)
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2010. 04. 05.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	Y.H.CHOI	
MATERIAL	_____	CHECKED BY		TITLE MCX50-PC-1.5D-2V
		DRAWN BY		
FINISH	_____	SCALE	6/1	DWG NO. CN02222-7/2
		UNIT	mm	REVISION O R SHEET 1 of 1

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